DISCRETE SEMICONDUCTORS

DATA SHEET

PDTC114E series NPN resistor-equipped transistor; R1 = 10 kΩ, R2 = 10 kΩ

Product specification Supersedes data of 2003 Apr 10 2004 Aug 05





PDTC114E series

FEATURES

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- · General purpose switching and amplification
- · Inverter and interface circuits
- · Circuit driver.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	50	V
Io	output current (DC)	_	100	mA
R1	bias resistor	10	_	kΩ
R2	bias resistor	10	_	kΩ

DESCRIPTION

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE NUMBER	PACE	KAGE	MARKING CODE	PNP COMPLEMENT
I TPE NUMBER	PHILIPS	EIAJ	WARKING CODE	PNP COMPLEMENT
PDTC114EE	SOT416	SC-75	09	PDTA114EE
PDTC114EEF	SOT490	SC-89	09	PDTA114EEF
PDTC114EK	SOT346	SC-59	04	PDTA114EK
PDTC114EM	SOT883	SC-101	DS	PDTA114EM
PDTC114ES	SOT54 (TO-92)	SC-43	TC114E	PDTA114ES
PDTC114ET	SOT23	_	*16 ⁽¹⁾	PDTA114ET
PDTC114EU	SOT323	SC-70	*09(1)	PDTA114EU

Note

^{1. * =} p: Made in Hong Kong.

^{* =} t: Made in Malaysia.

^{* =} W: Made in China.

NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	CIMPLIFIED OUTLINE AND CYMPOL	PINNING		
TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PIN	DESCRIPTION	
PDTC114ES	2 R1 R2 3 MAM364	1 2 3	base collector emitter	
PDTC114EE PDTC114EEF PDTC114EK PDTC114ET PDTC114EU	3 1 R1 R2 2 Top view MDB269	1 2 3	base emitter collector	
PDTC114EM	2 1 R1 R2 2 bottom view MHC506	1 2 3	base emitter collector	

NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL PARAMETER		CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	10	V
V _I	input voltage				
	positive		_	+40	V
	negative		_	-10	V
Io	output current (DC)		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT54	note 1	_	500	mW
	SOT23	note 1	_	250	mW
	SOT346	note 1	_	250	mW
	SOT323	note 1	_	200	mW
	SOT416	note 1	_	150	mW
	SOT490	notes 1 and 2	_	250	mW
	SOT883	notes 2 and 3	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μm copper strip line.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT416	note 1	833	K/W
	SOT490	notes 1 and 2	500	K/W
	SOT883	notes 2 and 3	500	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 µm copper strip line.

NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	_	_	1	μΑ
		V _{CE} = 30 V; I _B = 0; T _j = 150 °C	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	_	_	400	μΑ
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 5 mA	30	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 10 mA; I _B = 0.5 mA	_	_	150	mV
V _{i(off)}	input-off voltage	$I_C = 100 \mu\text{A}; V_{CE} = 5 \text{V}$	_	1.1	0.8	V
V _{i(on)}	input-on voltage	I _C = 10 mA; V _{CE} = 0.3 V	2.5	1.8	_	V
R1	input resistor		7	10	13	kΩ
R2 R1	resistor ratio		0.8	1	1.2	
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 10 V; f = 1 MHz	_	-	2.5	pF

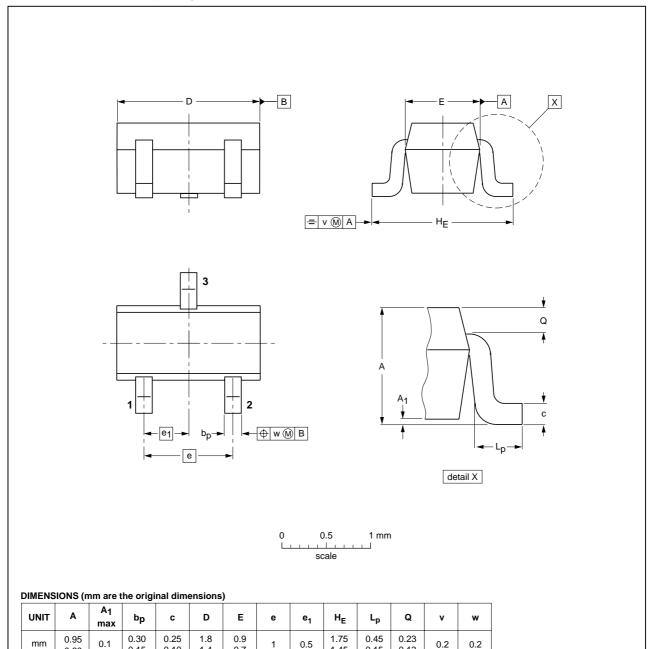
NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

PACKAGE OUTLINES

Plastic surface mounted package; 3 leads

SOT416



OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT416			SC-75			97-02-28	

1.45

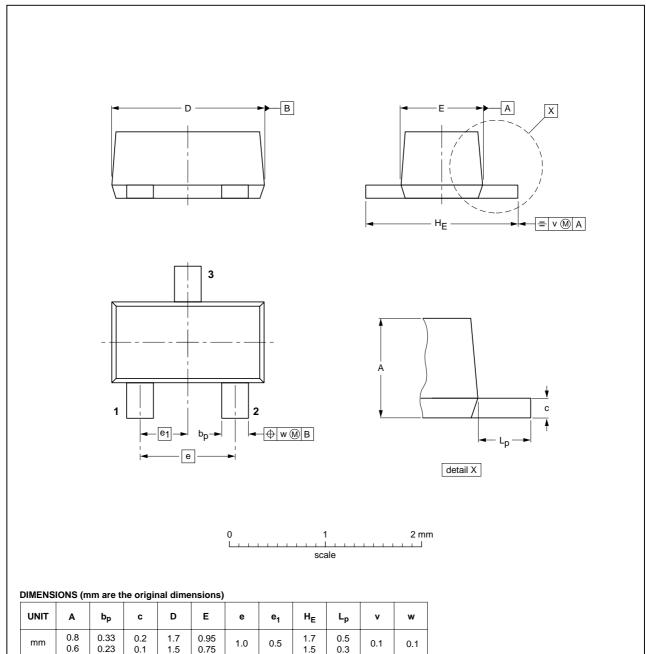
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PDTC114E series

Plastic surface mounted package; 3 leads

SOT490



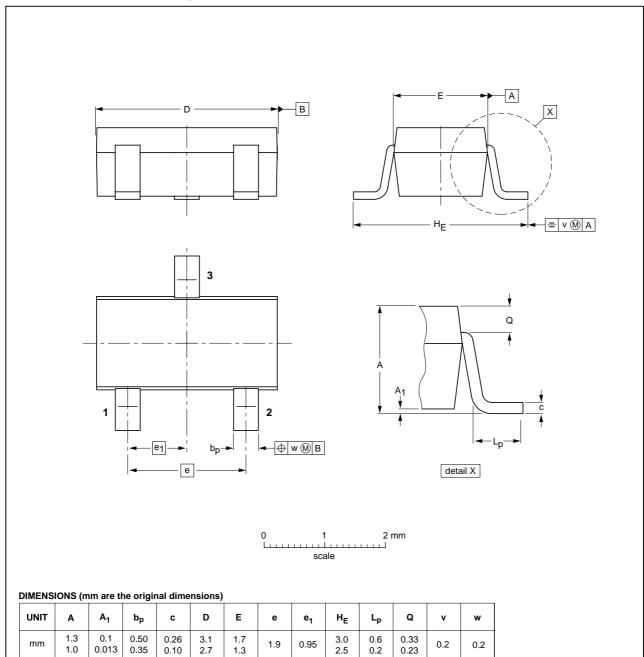
VERSION IEC JEDEC EIAJ PROJECTION	OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
SOT490 SC-89 98-10-23	VERSION	IEC	JEDEC	EIAJ	PROJECTION		
	SOT490			SC-89		98-10-23	

NPN resistor-equipped transistor; $R1 = 10 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

PDTC114E series

Plastic surface mounted package; 3 leads

SOT346



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT346		TO-236	SC-59		98-07-17	
•						

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1.0

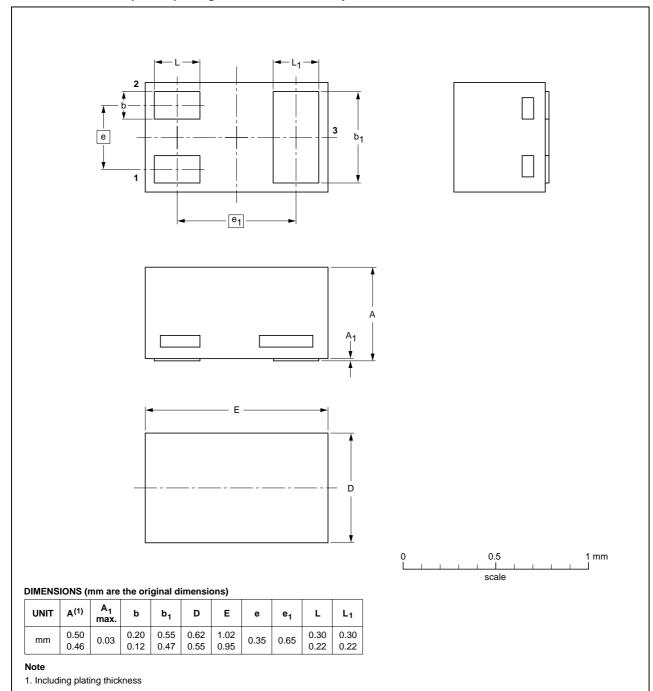
0.013

NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



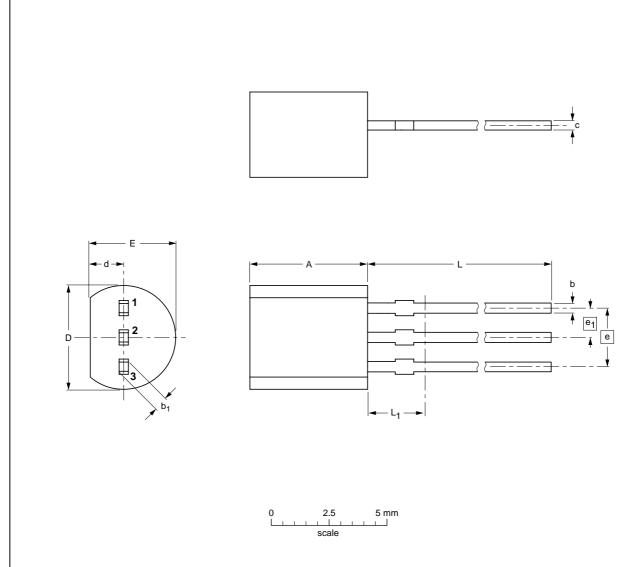
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT883			SC-101			03-02-05 03-04-03	

NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

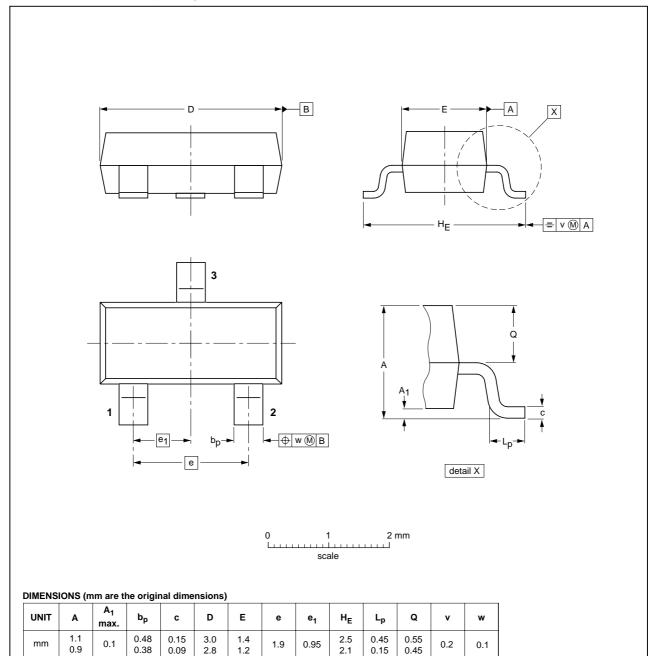
1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT54		TO-92	SC-43A			97-02-28 04-06-28	

PDTC114E series

Plastic surface mounted package; 3 leads

SOT23

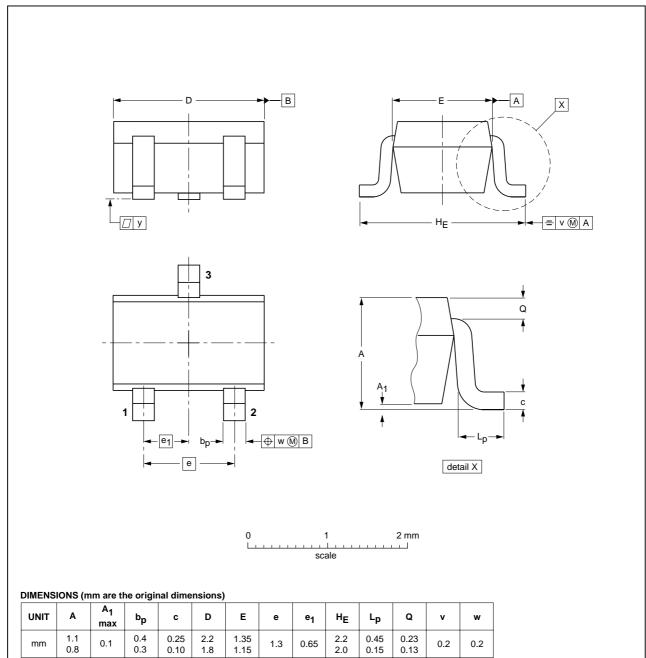


OUTLINE	REFERENCES				EUROPEAN	IOOUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT23		TO-236AB				-97-02-28 99-09-13

PDTC114E series

Plastic surface mounted package; 3 leads

SOT323



OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT323			SC-70			97-02-28

NPN resistor-equipped transistor; R1 = 10 k Ω , R2 = 10 k Ω

PDTC114E series

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Notes

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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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